



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > FFC Contacts



Centerline (Pitch): **2.54 mm [ .1 in ]**

Compatible With Wire & Cable Type: **FFC**

Contact Type: **Socket**

Contact Mating Area Plating Material: **Gold**

Packaging Method: **Reel**

## Features

### Product Type Features

|                                   |              |
|-----------------------------------|--------------|
| Connector & Contact Terminates To | Wire & Cable |
|-----------------------------------|--------------|

### Configuration Features

|                                   |     |
|-----------------------------------|-----|
| Compatible With Wire & Cable Type | FFC |
|-----------------------------------|-----|

### Contact Features

|                                      |                  |
|--------------------------------------|------------------|
|                                      | 15 µin           |
| Contact Underplating Material        | Palladium Nickel |
| Contact Base Material                | Phosphor Bronze  |
| Contact Type                         | Socket           |
| Contact Mating Area Plating Material | Gold             |
| Contact Current Rating (Max)         | 2 A              |

### Termination Features

|                                    |                               |
|------------------------------------|-------------------------------|
| Termination Method to Wire & Cable | Insulation Displacement (IDC) |
|------------------------------------|-------------------------------|

### Housing Features

|                    |                |
|--------------------|----------------|
| Centerline (Pitch) | 2.54 mm[.1 in] |
|--------------------|----------------|

### Dimensions



|                         |                  |
|-------------------------|------------------|
| Accepts Conductor Width | 1.27 mm, 1.62 mm |
|-------------------------|------------------|

### Usage Conditions

|                             |                            |
|-----------------------------|----------------------------|
| Operating Temperature Range | -65 – 105 °C[-85 – 221 °F] |
|-----------------------------|----------------------------|

### Operation/Application

|                     |        |
|---------------------|--------|
| Circuit Application | Signal |
|---------------------|--------|

### Packaging Features

|                  |      |
|------------------|------|
| Packaging Method | Reel |
|------------------|------|

## Product Compliance

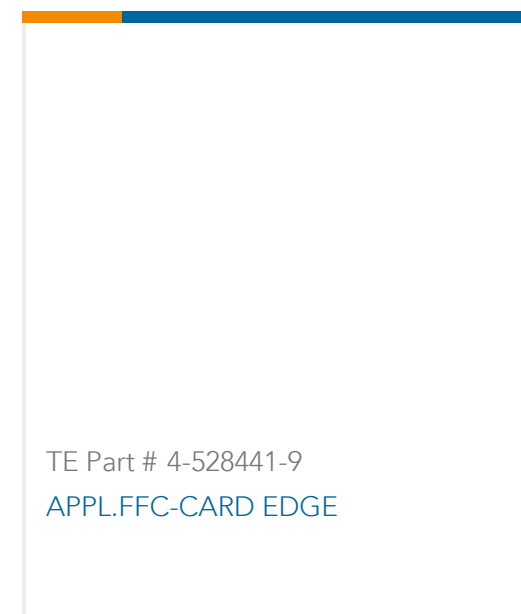
[For compliance documentation, visit the product page on TE.com>](#)

|   |   |
|---|---|
| EU RoHS Directive 2011/65/EU                  | Compliant   |
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2023 (235)<br>Candidate List Declared Against: JUNE 2023 (235)<br>Does not contain REACH SVHC |
| Halogen Content                               | Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free   |
| Solder Process Capability                     | Reflow solder capable to 260°C  |

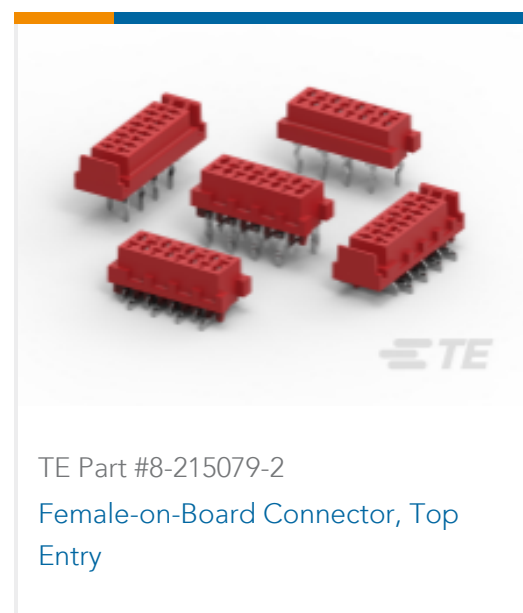
#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts



## Customers Also Bought



## Documents

### Product Drawings

#### FFC,CARD EDGE CONTACT

English

### CAD Files

#### Customer View Model

[ENG\\_CVM\\_CVM\\_485800-5\\_AK.2d\\_dxf.zip](#)

English

#### 3D PDF

3D

#### Customer View Model

[ENG\\_CVM\\_CVM\\_485800-5\\_AK.3d\\_igs.zip](#)

English

#### Customer View Model

[ENG\\_CVM\\_CVM\\_485800-5\\_AK.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.



**Product Specifications**

**Application Specification**

English

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**Product Environmental Compliance**

[MD\\_485800-5\\_021520172353\\_dmtec](#)

English

[MD\\_485800-5\\_021520172353\\_dmtec](#)

English